

**SURFACE MOUNT SCHOTTKY BARRIER DIODE**
**Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Fast Switching Time
- Low Reverse Capacitance
- Surface Mount Package Ideally Suited for Automated Insertion
- **Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)**

**Mechanical Data**

- Case: SOD-123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- Polarity: Cathode Band
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)



Top View

**Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                                                     | Symbol              | Value | Unit |
|--------------------------------------------------------------------|---------------------|-------|------|
| Peak Repetitive Reverse Voltage                                    | V <sub>RRM</sub>    | 60    | V    |
| Working Peak Reverse Voltage                                       | V <sub>RWM</sub>    |       |      |
| DC Blocking Voltage                                                | V <sub>R</sub>      |       |      |
| RMS Reverse Voltage                                                | V <sub>R(RMS)</sub> | 42    | V    |
| Forward Continuous Current                                         | I <sub>F</sub>      | 15    | mA   |
| Non-Repetitive Peak Forward Surge Current @ t ≤ 1.0s<br>@ t = 10ms | I <sub>FSM</sub>    | 50    | mA   |
|                                                                    |                     | 2.0   | A    |

**Thermal Characteristics**

| Characteristic                                       | Symbol           | Value       | Unit |
|------------------------------------------------------|------------------|-------------|------|
| Power Dissipation (Note 1)                           | P <sub>D</sub>   | 333         | mW   |
| Thermal Resistance, Junction to Ambient Air (Note 1) | R <sub>θJA</sub> | 300         | °C/W |
| Operating Temperature Range                          | T <sub>J</sub>   | -55 to +125 | °C   |
| Storage Temperature Range                            | T <sub>STG</sub> | -55 to +150 | °C   |

**Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                     | Symbol             | Min | Typ | Max         | Unit | Test Condition                                                                                            |
|------------------------------------|--------------------|-----|-----|-------------|------|-----------------------------------------------------------------------------------------------------------|
| Reverse Breakdown Voltage (Note 2) | V <sub>(BR)R</sub> | 60  | —   | —           | V    | I <sub>R</sub> = 10μA                                                                                     |
| Reverse Leakage Current (Note 2)   | I <sub>RM</sub>    | —   | —   | 200         | nA   | V <sub>R</sub> = 50V                                                                                      |
| Forward Voltage Drop               | V <sub>FM</sub>    | —   | —   | 0.41<br>1.0 | V    | I <sub>F</sub> = 1.0mA<br>I <sub>F</sub> = 15mA                                                           |
| Total Capacitance                  | C <sub>T</sub>     | —   | —   | 2.2         | pF   | V <sub>R</sub> = 0V, f = 1.0MHz                                                                           |
| Reverse Recovery Time              | t <sub>rr</sub>    | —   | —   | 1.0         | ns   | I <sub>F</sub> = I <sub>R</sub> = 5.0mA<br>I <sub>rr</sub> = 0.1 × I <sub>R</sub> , R <sub>L</sub> = 100Ω |

- Notes:
1. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
  2. Short duration pulse test used to minimize self-heating effect.
  3. No purposefully added lead. Halogen and Antimony Free.
  4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.

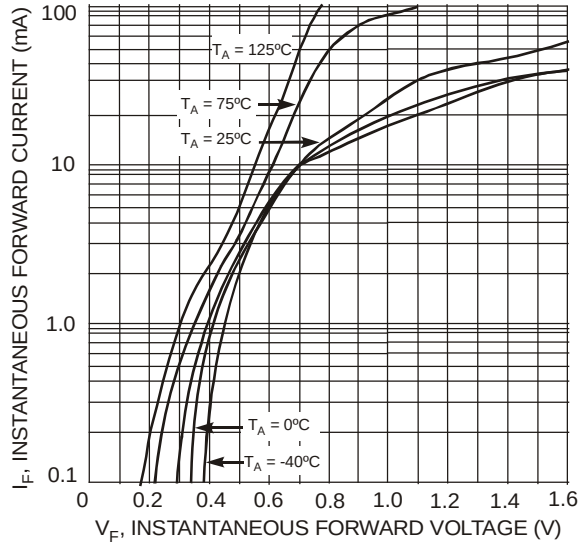


Fig. 1 Typical Forward Characteristics

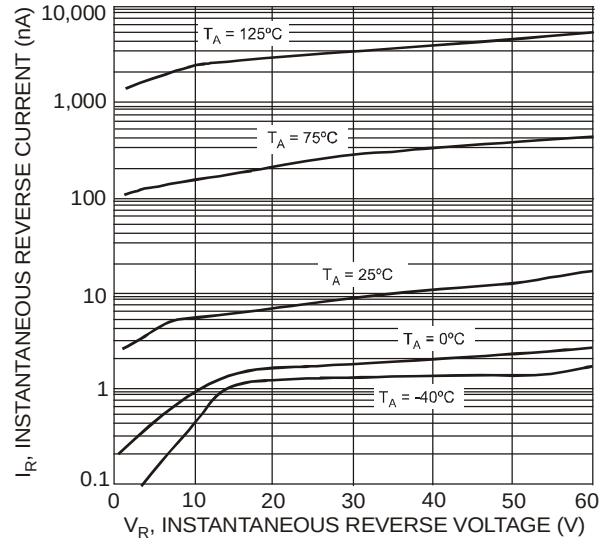


Fig. 2 Typical Reverse Characteristics

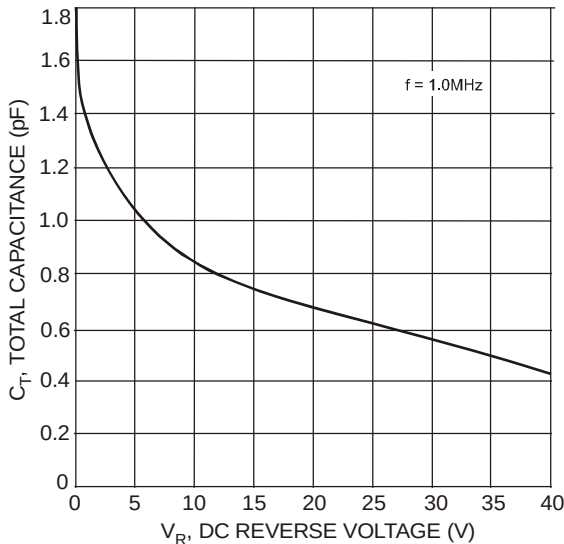


Fig. 3 Total Capacitance vs. Reverse Current

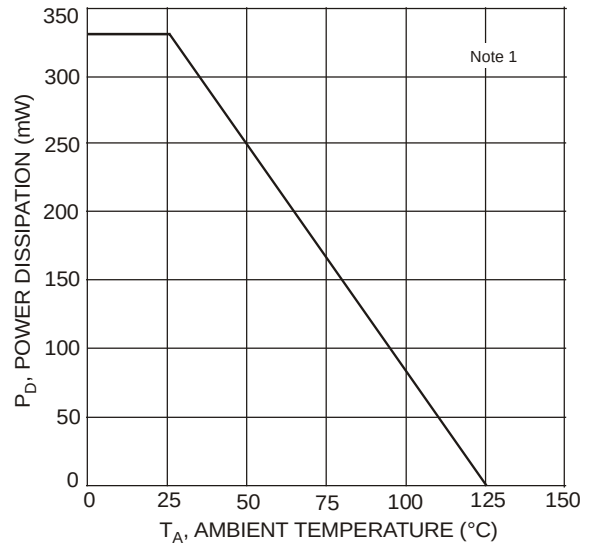


Fig. 4 Power Derating Curve

## Ordering Information (Note 5)

| Part Number | Case    | Packaging          |
|-------------|---------|--------------------|
| 1N6263W-7-F | SOD-123 | 3000/Tape and Reel |

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

## Marking Information

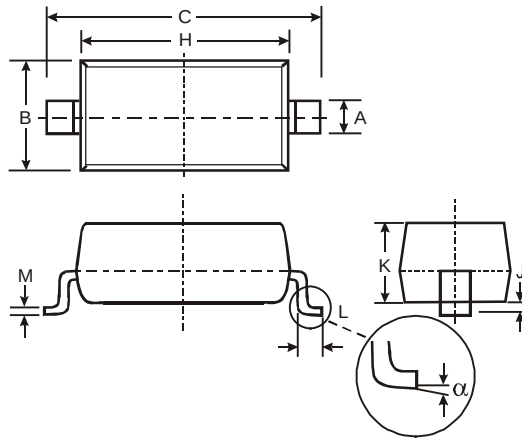


SB = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: T = 2006)  
 M = Month (ex: 9 = September)

### Date Code Key

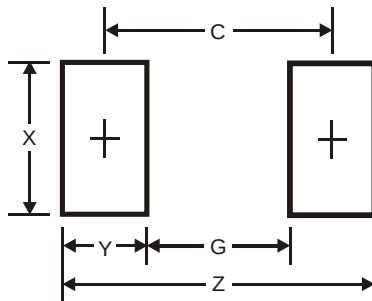
| Year  | 1998 | 1999 | 2000 | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code  | J    | K    | L    | M    | N    | P    | R    | S    | T    | U    | V    | W    | X    | Y    | Z    | A    | B    | C    |
| Month | Jan  | Feb  | Mar  | Apr  | May  | Jun  | Jul  | Aug  | Sep  | Oct  | Nov  | Dec  |      |      |      |      |      |      |
| Code  | 1    | 2    | 3    | 4    | 5    | 6    | 7    | 8    | 9    | O    | N    | D    |      |      |      |      |      |      |

## Package Outline Dimensions



| SOD-123              |          |      |
|----------------------|----------|------|
| Dim                  | Min      | Max  |
| A                    | 0.55 Typ |      |
| B                    | 1.40     | 1.70 |
| C                    | 3.55     | 3.85 |
| H                    | 2.55     | 2.85 |
| J                    | 0.00     | 0.10 |
| K                    | 1.00     | 1.35 |
| L                    | 0.25     | 0.40 |
| M                    | 0.10     | 0.15 |
| $\alpha$             | 0        | 8°   |
| All Dimensions in mm |          |      |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 4.9           |
| G          | 2.5           |
| X          | 0.7           |
| Y          | 1.2           |
| C          | 3.7           |

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